

MOS FIELD EFFECT TRANSISTOR 2SK3902

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3902 is N-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

| PART NUMBER | PACKAGE |
|-------------|------------------|
| 2SK3902-ZK | TO-263 (MP-25ZK) |

FEATURES

• Super low On-state resistance

 $R_{DS(on)1} = 21 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_D = 15 \text{ A})$

 $R_{DS(on)2} = 26 \text{ m}\Omega \text{ MAX.} \text{ (V}_{GS} = 4.5 \text{ V}, I_{D} = 15 \text{ A})$

- Low Ciss: Ciss = 1200 pF TYP.
- Built-in gate protection diode

(TO-263)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| Drain to Source Voltage (V _{GS} = 0 V) | VDSS | 60 | V |
|---|-----------------|-------------|----|
| Gate to Source Voltage (V _{DS} = 0 V) | Vgss | ±20 | V |
| Drain Current (DC) (Tc = 25°C) | ID(DC) | ±30 | Α |
| Drain Current (pulse) Note1 | D(pulse) | ±90 | Α |
| Total Power Dissipation (Tc = 25°C) | P _{T1} | 45 | W |
| Total Power Dissipation (T _A = 25°C) | P _{T2} | 1.5 | W |
| Channel Temperature | Tch | 150 | °C |
| Storage Temperature | Tstg | -55 to +150 | °C |
| Single Avalanche Energy Note2 | Eas | 40 | mJ |
| Repetitive Avalanche Current Note3 | lar | 20 | Α |
| Repetitive Avalanche Energy Note3 | Ear | 40 | mJ |

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- **2.** Starting T_{ch} = 25°C, V_{DD} = 30 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V, L = 100 μ H
- 3. Rg = 25 Ω , Tch(peak) $\leq 150^{\circ}$ C

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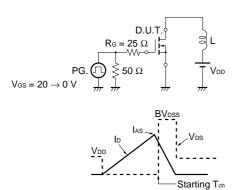


ELECTRICAL CHARACTERISTICS (TA = 25°C)

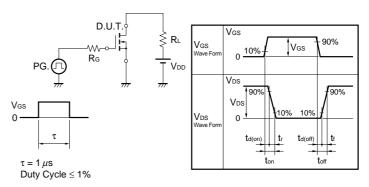
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|----------------------|--|------|------|------|------|
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 60 V, V _{GS} = 0 V | | | 10 | μΑ |
| Gate Leakage Current | Igss | V _{GS} = ±20 V, V _{DS} = 0 V | | | ±10 | μΑ |
| Gate Cut-off Voltage | V _{GS(off)} | V _{DS} = 10 V, I _D = 1 mA | 1.5 | 2.0 | 2.5 | V |
| Forward Transfer Admittance Note | y _{fs} | V _{DS} = 10 V, I _D = 15 A | 9.5 | 19 | | S |
| Drain to Source On-state Resistance Note | R _{DS(on)1} | V _{GS} = 10 V, I _D = 15 A | | 16.8 | 21 | mΩ |
| | R _{DS(on)2} | V _{GS} = 4.5 V, I _D = 15 A | | 19.5 | 26 | mΩ |
| Input Capacitance | Ciss | V _{DS} = 10 V | | 1200 | | pF |
| Output Capacitance | Coss | V _{GS} = 0 V | | 250 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 85 | | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 30 V, I _D = 15 A | | 10 | | ns |
| Rise Time | tr | V _{GS} = 10 V | | 4 | | ns |
| Turn-off Delay Time | t _{d(off)} | R _G = 0 Ω | | 37 | | ns |
| Fall Time | tr | | | 4 | | ns |
| Total Gate Charge | Q _G | V _{DD} = 48 V | | 25 | | nC |
| Gate to Source Charge | Qgs | V _{GS} = 10 V | | 4.5 | | nC |
| Gate to Drain Charge | Q _{GD} | ID = 30 A | | 6.0 | | nC |
| Body Diode Forward Voltage Note | V _{F(S-D)} | I _F = 30 A, V _{GS} = 0 V | | 0.92 | 1.5 | V |
| Reverse Recovery Time | trr | I _F = 30 A, V _{GS} = 0 V | | 31 | | ns |
| Reverse Recovery Charge | Qrr | di/dt = 100 A/μs | | 34 | | nC |

Note Pulsed

TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

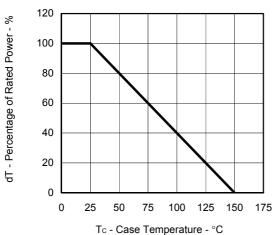


TEST CIRCUIT 3 GATE CHARGE

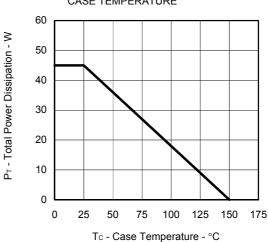
PG.
$$\square$$
 $\stackrel{Q}{\rightleftharpoons}$ $\stackrel{Q}{\rightleftharpoons$

TYPICAL CHARACTERISTICS (TA = 25°C)

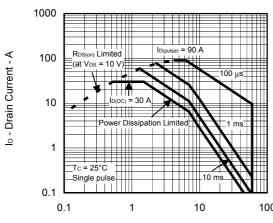
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

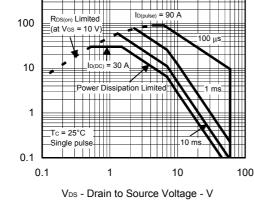


TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

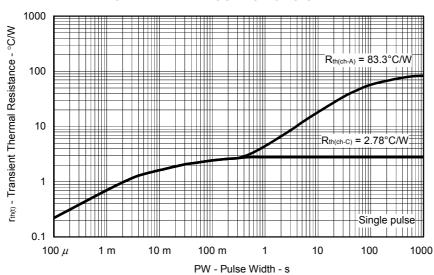


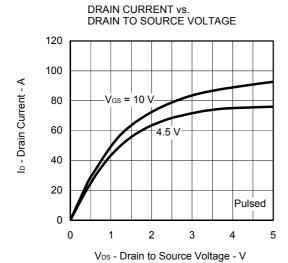
FORWARD BIAS SAFE OPERATING AREA

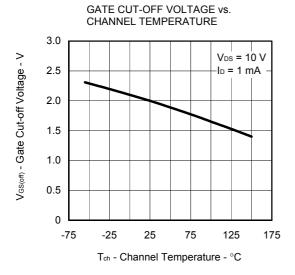


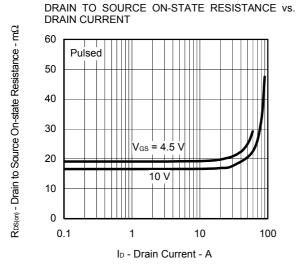


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

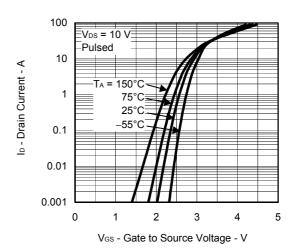




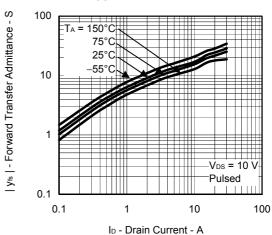




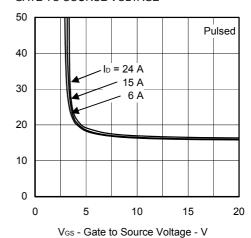




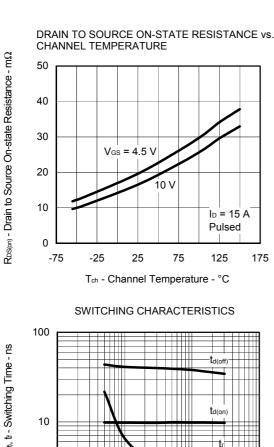
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

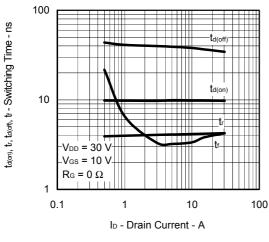


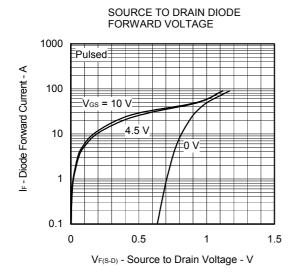
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



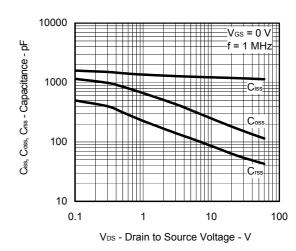
R_{DS(σ1)} - Drain to Source On-state Resistance - mΩ



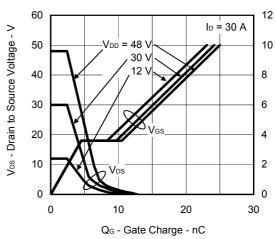




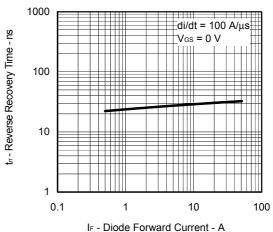




DYNAMIC INPUT/OUTPUT CHARACTERISTICS

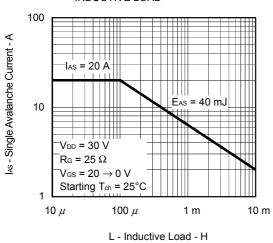


REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

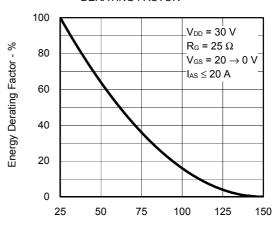


Vos - Gate to Source Voltage - V

SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



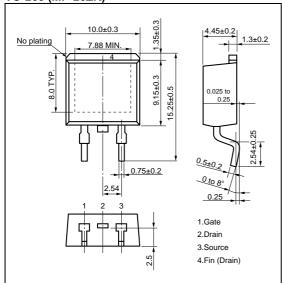
SINGLE AVALANCHE ENERGY DERATING FACTOR



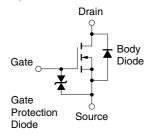
Starting T_{ch} - Starting Channel Temperature - $^{\circ}\text{C}$

PACKAGE DRAWING (Unit: mm)

TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

Data Sheet D17177EJ1V0DS 7

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